



Notification of Product/Process Change

Doc. No.: 1024003

This letter intends as a formal notification of change to products which are currently supplied by ROHM Co., Ltd.

ROHM Co., Ltd. requires customers to provide acknowledgment of the receipt of this notification within 30 days from the date of this notice. Lack of acknowledgment of this notice within 30 days is considered as acceptance of the change.

After acknowledgement of the customer, lack of additional response within 90 day period constitutes acceptance of the change according to JEDEC Standard J-STD-046.

Your understanding and cooperation would be highly appreciated.

Issue Date: Mrz 1.2024

Title of change	Application to switch OSAT* due to discontinuation of production line for LSI DIP7F package. *OSAT(Outsourced Semiconductor Assembly and Test)	
Affected product(s)	Manufacturer part number	Customer part number
	See Attachment	See Attachment
Detailed description of change	Before	After
	•Package name : DIP7F •OSAT name : TFME	•Package name : DIP7K •OSAT name : GREATEK
Reason for change	Tongfu Microelectronics Co., Ltd. (hereinafter referred to as the "TFME") will discontinue its DIP7F package assembly line due to aging equipment. For supply stabilization, we will switch to DIP7K package, which is assembled by GREATEK Electronics Inc. (hereinafter referred to as the "GREATEK").	
Anticipated impact on quality	There are no impacts on quality.	
Identification of change	The product can be identified on the product label as new internal product name.	
Planned first ship date	Mai 1.2025	
Qualification plan schedule, results and samples	If required, please contact the local ROHM sales office or the authorized distributor.	
Comments		
Supplier contact	Please contact the local ROHM sales office or the authorized distributor.	
Notes		